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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	372
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-7f672c

Architecture Overview

Each LatticeECP2/M device contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM™ Embedded Block RAM (EBR) and rows of sys-DSP™ Digital Signal Processing blocks, as shown in Figure 2-1. In addition, the LatticeECP2M family contains SERDES Quads in one or more of the corners. Figure 2-2 shows the block diagram of ECP2M20 with one quad.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional Unit without RAM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM and ROM functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row.

The LatticeECP2/M devices contain one or more rows of sysMEM EBR blocks. sysMEM EBRs are large dedicated 18K fast memory blocks. Each sysMEM block can be configured in a variety of depths and widths of RAM or ROM. In addition, LatticeECP2/M devices contain up to two rows of DSP Blocks. Each DSP block has multipliers and adder/accumulators, which are the building blocks for complex signal processing capabilities.

The LatticeECP2M devices feature up to 16 embedded 3.125Gbps SERDES (Serializer / Deserializer) channels. Each SERDES channel contains independent 8b/10b encoding / decoding, polarity adjust and elastic buffer logic. Each group of four SERDES channels along with its Physical Coding Sub-layer (PCS) block, creates a quad. The functionality of the SERDES/PCS Quads can be controlled by memory cells set during device configuration or by registers that are addressable during device operation. The registers in every quad can be programmed by a soft IP interface, referred to as the SERDES Client Interface (SCI). These quads (up to four) are located at the corners of the devices.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O buffers. The sysI/O buffers of the LatticeECP2/M devices are arranged in eight banks, allowing the implementation of a wide variety of I/O standards. In addition, a separate I/O bank is provided for the programming interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. The PIC logic also includes pre-engineered support to aid in the implementation of high speed source synchronous standards such as SPI4.2, along with memory interfaces including DDR2.

The LatticeECP2/M registers in PFU and sysI/O can be configured to be SET or RESET. After power up and the device is configured, it enters into user mode with these registers SET/RESET according to the configuration setting, allowing the device entering to a known state for predictable system function.

Other blocks provided include PLLs, DLLs and configuration functions. The LatticeECP2/M architecture provides two General PLLs (GPLL) and up to six Standard PLLs (SPLL) per device. In addition, each LatticeECP2/M family member provides two DLLs per device. The GPLLs and DLLs blocks are located in pairs at the end of the bottom-most EBR row; the DLL block is located towards the edge of the device. The SPLL blocks are located at the end of the other EBR/DSP rows.

The configuration block that supports features such as configuration bit-stream decryption, transparent updates and dual boot support is located toward the center of this EBR row. The Ball Grid Array (BGA) package devices in the LatticeECP2/M family supports a sysCONFIG™ port located in the corner between banks four and five, which allows for serial or parallel device configuration.

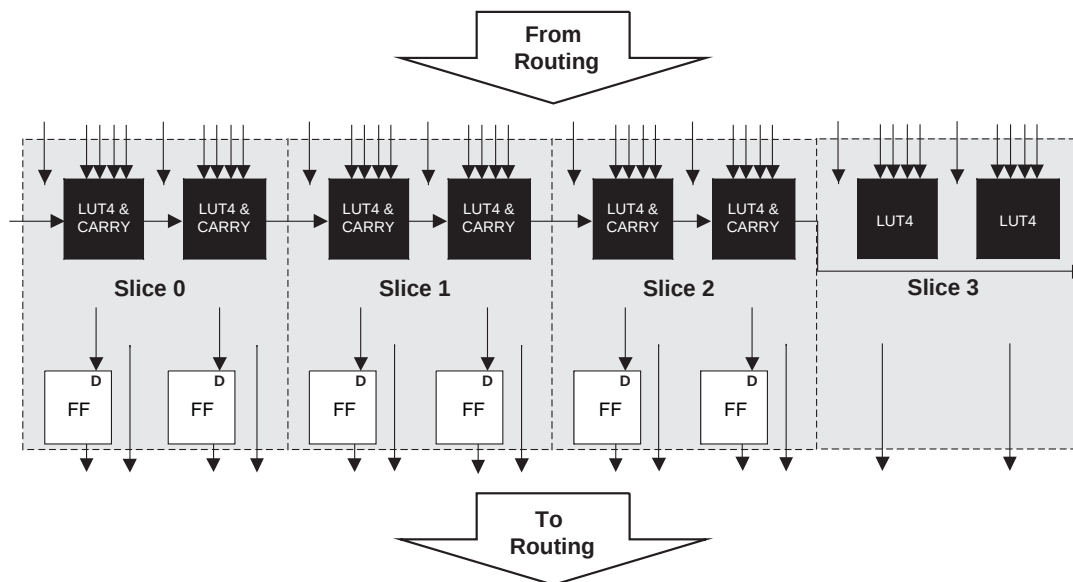
In addition, every device in the family has a JTAG port. This family also provides an on-chip oscillator. The LatticeECP2/M devices use 1.2V as their core voltage.

PFU Blocks

The core of the LatticeECP2/M device consists of PFU blocks, which are provided in two forms, the PFU and PFF. The PFUs can be programmed to perform Logic, Arithmetic, Distributed RAM and Distributed ROM functions. PFF blocks can be programmed to perform Logic, Arithmetic and ROM functions. Except where necessary, the remainder of this data sheet will use the term PFU to refer to both PFU and PFF blocks.

Each PFU block consists of four interconnected slices, numbered 0-3 as shown in Figure 2-3. All the interconnections to and from PFU blocks are from routing. There are 50 inputs and 23 outputs associated with each PFU block.

Figure 2-3. PFU Diagram



Slice

Slice 0 through Slice 2 contain two LUT4s feeding two registers, whereas Slice 3 contains two LUT4s only. For PFUs, Slice 0 and Slice 2 can also be configured as distributed memory, a capability not available in the PFF. Table 2-1 shows the capability of the slices in both PFF and PFU blocks along with the operation modes they enable. In addition, each PFU contains some logic that allows the LUTs to be combined to perform functions such as LUT5, LUT6, LUT7 and LUT8. There is control logic to perform set/reset functions (programmable as synchronous/asynchronous), clock select, chip-select and wider RAM/ROM functions. Figure 2-4 shows an overview of the internal logic of the slice. The registers in the slice can be configured for positive/negative and edge triggered or level sensitive clocks.

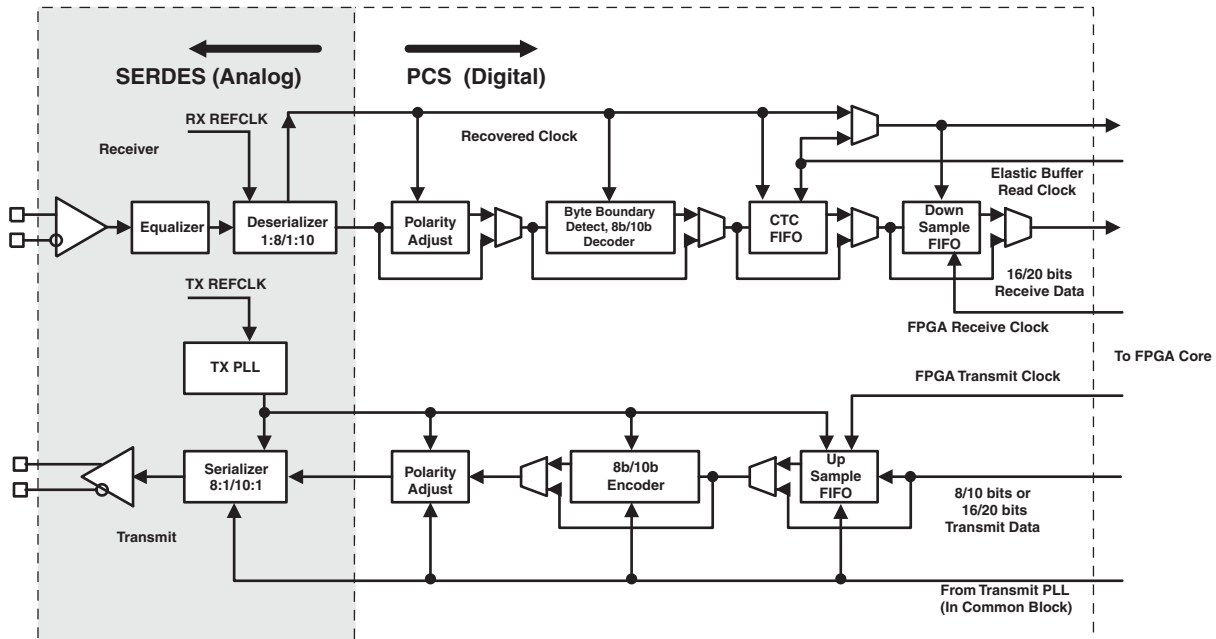
Table 2-1. Resources and Modes Available per Slice

Slice	PFU BLock		PFF Block	
	Resources	Modes	Resources	Modes
Slice 0	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 1	2 LUT4s and 2 Registers	Logic, Ripple, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 2	2 LUT4s and 2 Registers	Logic, Ripple, RAM, ROM	2 LUT4s and 2 Registers	Logic, Ripple, ROM
Slice 3	2 LUT4s	Logic, ROM	2 LUT4s	Logic, ROM

Slices 0, 1 and 2 have 14 input signals: 13 signals from routing and one from the carry-chain (from the adjacent slice or PFU). There are seven outputs: six to routing and one to carry-chain (to the adjacent PFU). Slice 3 has 13 input signals from routing and four signals to routing. Table 2-2 lists the signals associated with Slice 0 to Slice 2.

Each Transmit and Receive channel has its independent power supplies. The Output and Input buffers of each channel also have their own independent power supplies. In addition, there are separate power supplies for PLL, terminating resistor per quad.

Figure 2-40. Simplified Channel Block Diagram for SERDES and PCS



PCS

As shown in Figure 2-40, the PCS receives the parallel digital data from the deserializer receivers and adjusts the polarity, detects, byte boundary, decodes (8b/10b) and provides Clock Tolerance Compensation (CTC) FIFO for changing the clock domain from receiver clock to the FPGA Clock.

For the transmit channel, the PCS block receives the parallel data from the FPGA core, encodes it with 8b/10b, adjusts the polarity and passes the 8/10 bit data to the transmit SERDES channel.

The PCS also provides bypass modes that allow a direct 8-bit or 10-bit interface from the SERDES to the FPGA logic. The PCS interface to FPGA can also be programmed to run at 1/2 speed for a 16-bit or 20-bit interface to the FPGA logic.

SCI (SERDES Client Interface) Bus

The SERDES Client Interface (SCI) is a soft IP interface that allow the SERDES/PCS Quad block to be controlled by registers as opposed to the configuration memory cells. It is a simple register configuration interface.

The Diamond design tools support all modes of the PCS. Most modes are dedicated to applications associated with a specific industry standard data protocol. Other more general purpose modes allow users to define their own operation. With Diamond, the user can define the mode for each quad in a design.

Popular standards such as 10Gb Ethernet and x4 PCI-Express and 4x Serial RapidIO can be implemented using IP (provided by Lattice), a single quad (Four SERDES channels and PCS) and some additional logic from the core.

For further information about SERDES, please see the list of additional technical documentation at the end of this data sheet.

SERDES High-Speed Data Transmitter (LatticeECP2M Family Only)^{1, 2}

Table 3-7. Serial Output Timing and Levels

Symbol	Description	Frequency	Min.	Typ.	Max.	Units
V _{TX-DIFF-P-P-1}	Differential swing (1V setting) ^{1, 2}	0.25 to 3.125 Gbps	0.79	0.99	1.19	V, p-p
V _{TX-DIFF-P-P-1.25}	Differential swing (1.25V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.00	1.25	1.50	V, p-p
V _{TX-DIFF-P-P-1.3}	Differential swing (1.3V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.04	1.30	1.56	V, p-p
V _{TX-DIFF-P-P-1.35}	Differential swing (1.35V setting) ^{1, 2}	0.25 to 3.125 Gbps	1.08	1.35	1.62	V, p-p
V _{OCM}	Output common mode voltage	—	V _{CCOB} - 0.75	V _{CCOB} - 0.60	V _{CCOB} - 0.45	V
T _{TX-R}	Rise time (20% to 80%)	—	—	70	—	ps
T _{TX-F}	Fall time (80% to 20%)	—	—	70	—	ps
Z _{TX-OI-SE}	Output impedance 50/75/HiZ K Ohms (single-ended)	—	—	50/70 HiZ	—	Ohms
R _{TX-RL}	Return loss (with package)	—	—	9	—	dB

1. All measurements are with 50 ohm impedance.

2. See TN1124, [LatticeECP2M SERDES/PCS Usage Guide](#) for actual binary settings.

Table 3-8. Channel Output Jitter - x10 Mode

Description	Frequency	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	—	0.08	0.12	UI, p-p
Random	3.125 Gbps	—	0.22	0.38	UI, p-p
Total	3.125 Gbps	—	0.33	0.43	UI, p-p
Deterministic	2.5 Gbps	—	0.08	0.17	UI, p-p
Random	2.5 Gbps	—	0.20	0.25	UI, p-p
Total	2.5 Gbps	—	0.25	0.35	UI, p-p
Deterministic	1.25 Gbps	—	0.03	0.10	UI, p-p
Random	1.25 Gbps	—	0.14	0.19	UI, p-p
Total	1.25 Gbps	—	0.17	0.24	UI, p-p
Deterministic	250 Mbps	—	0.04	0.17	UI, p-p
Random	250 Mbps	—	0.12	0.13	UI, p-p
Total	250 Mbps	—	0.15	0.29	UI, p-p

Note: Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, reference clock at x10 mode.

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
f_{MAXSPI}	Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1)	—	20	MHz
	Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0)	—	50	MHz
	Max. CCLK Frequency - Encrypted Bitstream	—	10	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7	—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	2	—	ns
t_{SUMCDI}	DI Setup to CCLK	7	—	ns
t_{HMCDI}	DI Hold from CCLK	1	—	ns

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

Parameter	Min.	Max.	Units
Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
Duty Cycle	40	60	%

Figure 3-14. sysCONFIG Parallel Port Read Cycle

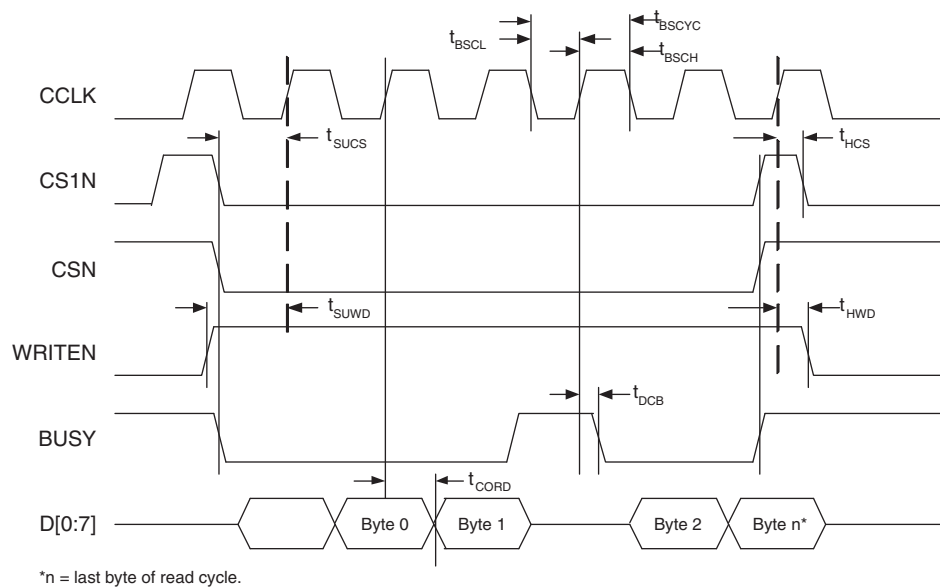
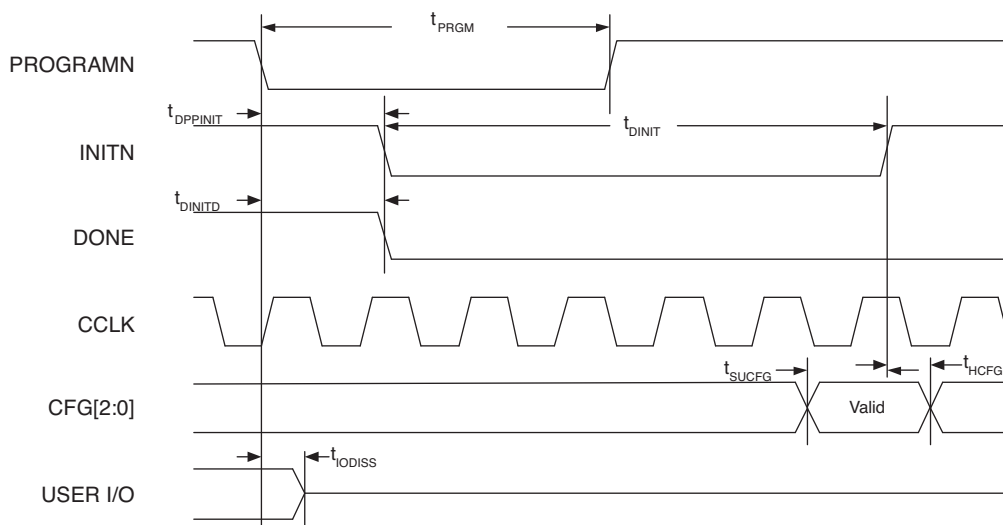


Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

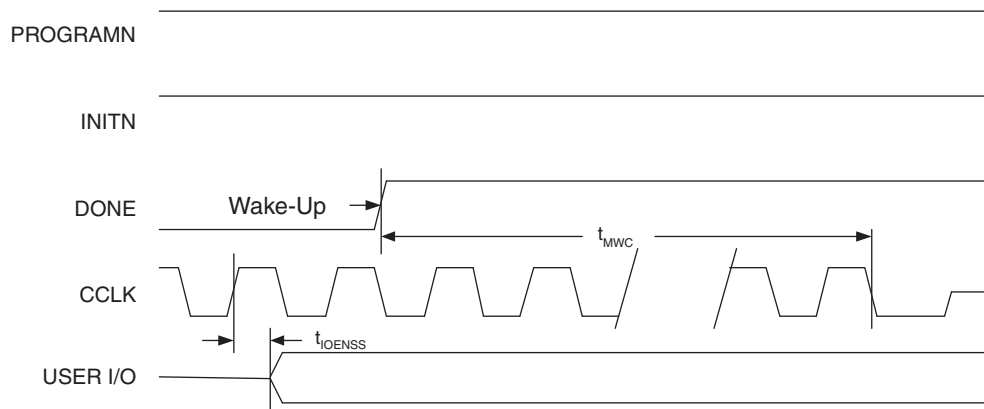
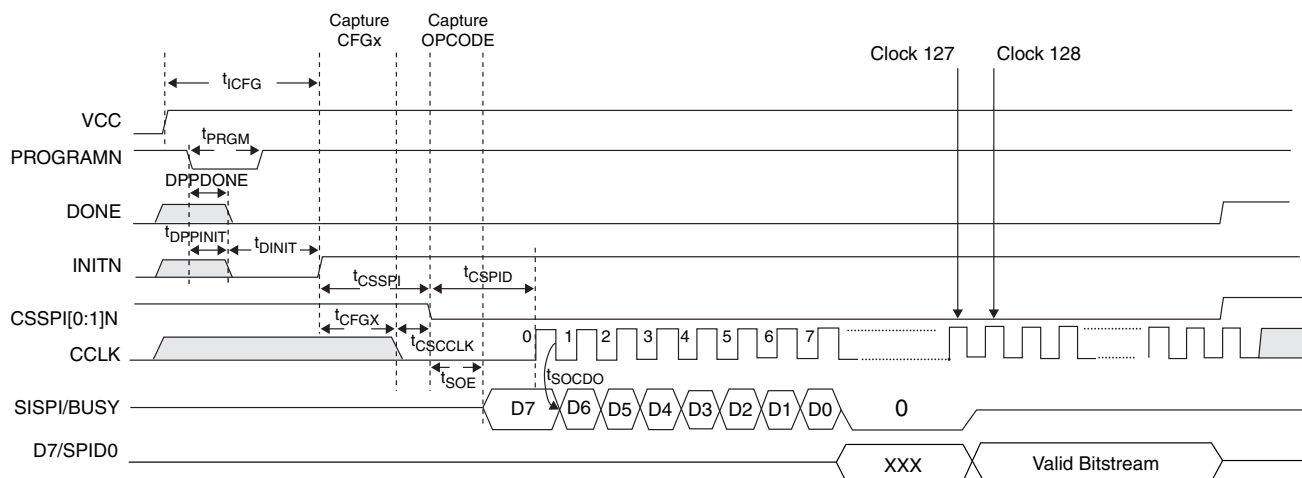


Figure 3-20. SPI/SPIm Configuration Waveforms



LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
1	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
2	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
3	PL4A	7		T (LVDS)*	PL6A	7	LDQ8	T (LVDS)*	
4	PL4B	7		C (LVDS)*	PL6B	7	LDQ8	C (LVDS)*	
5	GND	-			GND	-			
6	PL6A	7	LDQ10	T (LVDS)*	PL12A	7	LDQ16	T (LVDS)*	
7	VCCAUX	-			VCCAUX	-			
8	PL6B	7	LDQ10	C (LVDS)*	PL12B	7	LDQ16	C (LVDS)*	
9	PL8A	7	LDQ10	T (LVDS)*	PL14A	7	LDQ16	T (LVDS)*	
10	VCCIO7	7			VCCIO7	7			
11	PL8B	7	LDQ10	C (LVDS)*	PL14B	7	LDQ16	C (LVDS)*	
12	VCC	-			VCC	-			
13	GND	-			GND	-			
14	VCCIO7	7			VCCIO7	7			
15	PL12A	7	LDQ10	T (LVDS)*	PL18A	7	LDQ16	T (LVDS)*	
16	PL12B	7	LDQ10	C (LVDS)*	PL18B	7	LDQ16	C (LVDS)*	
17	GND	-			GND	-			
18	PL13A	7	PCLKT7_0/LDQ10	T	PL19A	7	PCLKT7_0/LDQ16	T	
19	VCC	-			VCC	-			
20	PL13B	7	PCLKC7_0/LDQ10	C	PL19B	7	PCLKC7_0/LDQ16	C	
21	PL15A	6	PCLKT6_0	T (LVDS)*	PL21A	6	PCLKT6_0/LDQ25	T (LVDS)*	
22	PL15B	6	PCLKC6_0	C (LVDS)*	PL21B	6	PCLKC6_0/LDQ25	C (LVDS)*	
23	PL16A	6	VREF2_6	T	PL22A	6	VREF2_6/LDQ25	T	
24	PL16B	6	VREF1_6	C	PL22B	6	VREF1_6/LDQ25	C	
25	GND	-			GND	-			
26	PL17A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	
27	PL17B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	
28	VCC	-			VCC	-			
29	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
30	VCCAUX	-			VCCAUX	-			
31	PL20A	6	LLM0_GPLLT_IN_A**	T (LVDS)*	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	
32	GND	-			GND	-			
33	PL21A	6	LLM0_GPLLT_FB_A	T	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	
34	PL20B	6	LLM0_GPLLC_IN_A**	C (LVDS)*	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	
35	PL21B	6	LLM0_GPLLC_FB_A	C	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	
36	PL23A	6			PL33A	6	LDQ34		
37	PL24A	6	LDQ28	T (LVDS)*	PL38A	6	LDQ42	T (LVDS)*	
38	VCCIO6	6			VCCIO6	6			
39	PL24B	6	LDQ28	C (LVDS)*	PL38B	6	LDQ42	C (LVDS)*	
40	VCC	-			VCC	-			
41	PL26A	6	LDQ28	T (LVDS)*	PL40A	6	LDQ42	T (LVDS)*	
42	GND	-			GND	-			
43	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
44	VCCIO6	6			VCCIO6	6			
45	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J13	J13	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C
J12	J12	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T
H12	H12	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*
GND	GND	GNDIO3	-		
H13	H13	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*
H15	H15	PR22B	3	VREF2_3/RDQ25	C
VCCIO	VCCIO	VCCIO3	3		
H16	H16	PR22A	3	VREF1_3/RDQ25	T
H11	H11	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*
J11	J11	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
G16	G16	PR19B	2	PCLKC2_0/RDQ16	C
GND	GND	GNDIO2	-		
G15	G15	PR19A	2	PCLKT2_0/RDQ16	T
F15	F15	PR17B	2	RDQ16	C
G11	G11	PR18B	2	RDQ16	C (LVDS)*
F14	F14	PR17A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
F12	F12	PR18A	2	RDQ16	T (LVDS)*
G14	G14	PR16B	2	RDQ16	C (LVDS)*
G13	G13	PR16A	2	RDQS16	T (LVDS)*
GND	GND	GNDIO2	-		
F16	F16	PR14B	2	RDQ16	C (LVDS)*
F9	F9	PR15B	2	RDQ16	C
E16	E16	PR14A	2	RDQ16	T (LVDS)*
F10	F10	PR15A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
D16	D16	PR13B	2	RDQ16	C
D15	D15	PR13A	2	RDQ16	T
C15	C15	PR6B	2	RDQ8	C (LVDS)*
C16	C16	PR7B	2	RDQ8	C
GND	GND	GNDIO2	-		
D14	D14	PR6A	2	RDQ8	T (LVDS)*
B16	B16	PR7A	2	RDQ8	T
F13	F13	PR2B	2	VREF2_2	C (LVDS)*
VCCIO	VCCIO	VCCIO2	2		
E13	E13	PR2A	2	VREF1_2	T (LVDS)*
F11	F11	PT64B	1	VREF2_1	C
E11	E11	PT64A	1	VREF1_1	T
GND	GND	GNDIO1	-		
A15	A15	PT63B	1		C
E12	E12	PT62B	1		C
B15	B15	PT63A	1		T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA
(Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AB7	PB13B	5	BDQ15	C	PB22B	5	BDQ24	C
Y8	PB16A	5	BDQ15	T	PB25A	5	BDQ24	T
GNDIO	GNDIO5	-			GNDIO	-		
W9	PB15A	5	BDQS15	T	PB24A	5	BDQS24	T
AA8	PB16B	5	BDQ15	C	PB25B	5	BDQ24	C
V9	PB15B	5	BDQ15	C	PB24B	5	BDQ24	C
AB8	PB18A	5	BDQ15	T	PB27A	5	BDQ24	T
VCCIO	VCCIO5	5			VCCIO5	5		
W10	PB17A	5	BDQ15	T	PB26A	5	BDQ24	T
AA9	PB18B	5	BDQ15	C	PB27B	5	BDQ24	C
V10	PB17B	5	BDQ15	C	PB26B	5	BDQ24	C
GNDIO	GNDIO5	-			GNDIO	-		
Y10	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AB9	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AB10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
AB11	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
U10	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AA11	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
U11	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
AB12	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
Y11	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AA12	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
W11	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AB13	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO5	5			VCCIO5	5		
AB14	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y12	PB32A	4	BDQ33	T	PB41A	4	BDQ42	T
W12	PB32B	4	BDQ33	C	PB41B	4	BDQ42	C
VCCIO	VCCIO4	4			VCCIO4	4		
U12	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T
V12	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C
U13	PB34A	4	BDQ33	T	PB43A	4	BDQ42	T
GNDIO	GNDIO4	-			GNDIO4	-		
AA13	PB33A	4	BDQS33	T	PB42A	4	BDQS42	T
U14	PB34B	4	BDQ33	C	PB43B	4	BDQ42	C
Y13	PB33B	4	BDQ33	C	PB42B	4	BDQ42	C
AB16	PB36A	4	BDQ33	T	PB45A	4	BDQ42	T
VCCIO	VCCIO4	4			VCCIO4	4		
AB15	PB35A	4	BDQ33	T	PB44A	4	BDQ42	T
AB17	PB36B	4	BDQ33	C	PB45B	4	BDQ42	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D15	PT52A	1		T	PT61A	1		T
E15	PT51B	1		C	PT60B	1		C
F15	PT51A	1		T	PT60A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
B15	PT49B	1		C	PT58B	1		C
VCCIO	VCCIO1	1			VCCIO	1		
A15	PT49A	1		T	PT58A	1		T
B14	PT48B	1		C	PT57B	1		C
A14	PT48A	1		T	PT57A	1		T
D14	PT46B	1		C	PT55B	1		C
C13	PT46A	1		T	PT55A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
E14	PT45B	1		C	PT54B	1		C
F14	PT45A	1		T	PT54A	1		T
A13	PT44B	1		C	PT53B	1		C
B13	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO	1		
E13	PT43B	1		C	PT52B	1		C
D13	PT43A	1		T	PT52A	1		T
E12	PT42B	1		C	PT51B	1		C
D12	PT42A	1		T	PT51A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A12	PT40B	1		C	PT49B	1		C
A11	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO	1		
B12	PT39B	1	PCLKC1_0	C	PT48B	1	PCLKC1_0	C
C12	PT39A	1	PCLKT1_0	T	PT48A	1	PCLKT1_0	T
F12	XRES	1			XRES	1		
B10	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	0		
B11	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T
A10	PT36B	0		C	PT45B	0		C
A9	PT36A	0		T	PT45A	0		T
C11	PT35B	0		C	PT44B	0		C
VCCIO	VCCIO0	0			VCCIO	0		
C10	PT35A	0		T	PT44A	0		T
E11	PT34B	0		C	PT43B	0		C
F11	PT34A	0		T	PT43A	0		T
A8	PT33B	0		C	PT42B	0		C
A7	PT33A	0		T	PT42A	0		T
B8	PT32B	0		C	PT41B	0		C
GNDIO	GNDIO0	-			GNDIO0	0		
B9	PT32A	0		T	PT41A	0		T
VCCIO	VCCIO0	0			VCCIO	0		
B7	PT30B	0		C	PT39B	0		C
A6	PT30A	0		T	PT39A	0		T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
VCCIO	VCCIO3	3			VCCIO3	3			
U20	PR58A	3	RLM0_GPLLT_IN_A**/RDQ57	T	PR63A	3	RLM0_GPLLT_IN_A	T	
W24	PR57B	3	RLM0_GPLLC_FB_A/RDQ57	C (LVDS)*	PR62B	3	RLM0_GPLLC_FB_A	C*	
V24	PR57A	3	RLM0_GPLLT_FB_A/RDQS57	T (LVDS)*	PR62A	3	RLM0_GPLLT_FB_A	T*	
GNDIO	GNDIO3	-			GNDIO3	-			
U21	PR56A	3	RDQ57	T	PR60A	3		T	
W25	PR55B	3	RDQ57	C (LVDS)*	PR59B	3		C*	
W26	PR55A	3	RDQ57	T (LVDS)*	PR59A	3		T*	
VCCIO	VCCIO3	3			VCCIO3	3			
U18	PR54B	3	RDQ57	C	PR58B	3		C	
U22	PR54A	3	RDQ57	T	PR58A	3		T	
V25	PR53B	3	RDQ57	C (LVDS)*	PR57B	3		C*	
V26	PR53A	3	RDQ57	T (LVDS)*	PR57A	3		T*	
U24	PR51B	3	RDQ48	C	PR55B	3	RDQ52	C	
T24	PR51A	3	RDQ48	T	PR55A	3	RDQ52	T	
GNDIO	GNDIO3	-			GNDIO3	-			
T22	PR50B	3	RDQ48	C (LVDS)*	PR54B	3	RDQ52	C*	
T23	PR50A	3	RDQ48	T (LVDS)*	PR54A	3	RDQ52	T*	
U25	PR49B	3	RDQ48	C	PR53B	3	RDQ52	C	
U26	PR49A	3	RDQ48	T	PR53A	3	RDQ52	T	
VCCIO	VCCIO3	3			VCCIO3	3			
T19	PR48B	3	RDQ48	C (LVDS)*	PR52B	3	RDQ52	C*	
R19	PR48A	3	RDQS48	T (LVDS)*	PR52A	3	RDQS52	T*	
R21	PR47B	3	RDQ48	C	PR51B	3	RDQ52	C	
GNDIO	GNDIO3	-			GNDIO3	-			
R20	PR47A	3	RDQ48	T	PR51A	3	RDQ52	T	
T26	PR46B	3	RDQ48	C (LVDS)*	PR50B	3	RDQ52	C*	
R26	PR46A	3	RDQ48	T (LVDS)*	PR50A	3	RDQ52	T*	
P21	PR45B	3	RDQ48	C	PR49B	3	RDQ52	C	
VCCIO	VCCIO3	3			VCCIO3	3			
P19	PR45A	3	RDQ48	T	PR49A	3	RDQ52	T	
R23	PR44B	3	RDQ48	C (LVDS)*	PR48B	3	RDQ52	C*	
R24	PR44A	3	RDQ48	T (LVDS)*	PR48A	3	RDQ52	T*	
-	-	-			GNDIO3	-			
R22	PR42B	3	RLM2_SPLLC_FB_A	C	PR46B	3	RLM3_SPLLC_FB_A	C	
VCCIO	VCCIO3	3			VCCIO3	3			
N19	PR42A	3	RLM2_SPLLT_FB_A	T	PR46A	3	RLM3_SPLLT_FB_A	T	
P23	PR41B	3	RLM2_SPLLC_IN_A	C (LVDS)*	PR45B	3	RLM3_SPLLC_IN_A	C*	
P24	PR41A	3	RLM2_SPLLT_IN_A	T (LVDS)*	PR45A	3	RLM3_SPLLT_IN_A	T*	
GNDIO	GNDIO3	-			GNDIO3	-			
N21	PR40B	3		C	PR44B	3		C	
P22	PR40A	3		T	PR44A	3		T	
N20	PR39B	3		C (LVDS)*	PR43B	3		C*	
N22	PR39A	3		T (LVDS)*	PR43A	3		T*	
VCCIO	VCCIO3	3			VCCIO3	3			
P25	PR38B	3	VREF2_3	C	PR42B	3	VREF2_3	C	
P26	PR38A	3	VREF1_3	T	PR42A	3	VREF1_3	T	
M21	PR37B	3	PCLKC3_0	C (LVDS)*	PR41B	3	PCLKC3_0	C*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T	
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C	
GNDIO	GNDIO7	-			GNDIO7	-			
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
GNDIO	GNDIO7	-			-	-			
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
E2	PL14A	7		T	PL14A	7	LDQ15	T	
D1	PL14B	7		C	PL14B	7	LDQ15	C	
-	-	-			GNDIO7	-			
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*	
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*	
K7	NC	-			PL16A	7	LDQ15	T	
K8	NC	-			PL16B	7	LDQ15	C	
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*	
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*	
F1	NC	-			PL18A	7	LDQ15	T	
-	-	-			GNDIO7	-			
G3	NC	-			PL18B	7	LDQ15	C	
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*	
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*	
J5	PL16A	7		T	PL22A	7		T	
J4	PL16B	7		C	PL22B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*	
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*	
L9	NC	-			PL25A	7	LDQ28	T	
L7	NC	-			PL25B	7	LDQ28	C	
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*	
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*	
L8	NC	-			PL27A	7	LDQ28	T	
L6	NC	-			PL27B	7	LDQ28	C	
-	-	-			GNDIO7	-			
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*	
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*	
N8	PL19A	7		T	PL29A	7	LDQ28	T	
M9	PL19B	7		C	PL29B	7	LDQ28	C	
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*	
VCCIO	VCCIO7	7			-	-			
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*	
H1	PL21A	7		T	PL31A	7	LDQ28	T	
GNDIO	GNDIO7	-			GNDIO7	-			
J1	PL21B	7		C	PL31B	7	LDQ28	C	
-	-	-			-	-			
-	-	-			-	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P16	GND	-			GND	-			
P17	GND	-			GND	-			
P18	GND	-			GND	-			
P20	GND	-			GND	-			
R10	GND	-			GND	-			
R11	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
R15	GND	-			GND	-			
R16	GND	-			GND	-			
R17	GND	-			GND	-			
R18	GND	-			GND	-			
R20	GND	-			GND	-			
R21	GND	-			GND	-			
R24	GND	-			GND	-			
R7	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T13	GND	-			GND	-			
T14	GND	-			GND	-			
T15	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T18	GND	-			GND	-			
T20	GND	-			GND	-			
T21	GND	-			GND	-			
T24	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U15	GND	-			GND	-			
U16	GND	-			GND	-			
U17	GND	-			GND	-			
U18	GND	-			GND	-			
U20	GND	-			GND	-			
V14	GND	-			GND	-			
V15	GND	-			GND	-			
V16	GND	-			GND	-			
V17	GND	-			GND	-			
V27	GND	-			GND	-			
V4	GND	-			GND	-			
W23	GND	-			GND	-			
W8	GND	-			GND	-			
Y14	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ30	LRC_SQ_VCCIB0	13		
AK29	LRC_SQ_HDINP0	13		T
AH30	LRC_SQ_VCCRX0	13		
AG27	CFG2	8		
AD25	CFG1	8		
AG28	CFG0	8		
AG30	PROGRAMN	8		
AG29	CCLK	8		
AC24	INITN	8		
AF27	DONE	8		
GNDIO	GNDIO8	-		
AF28	WRITEN***	8		
AE26	CS1N***	8		
AB23	CSN***	8		
AF29	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
AF30	D1***	8		
AD26	D2***	8		
AE29	D3***	8		
GNDIO	GNDIO8	-		
AE30	D4***	8		
AD29	D5***	8		
AC25	D6***	8		
AD30	D7/SPID0***	8		
VCCIO	VCCIO8	8		
AA22	DI/CSSPI0N***	8		
AC26	DOUT/CSON/CSSPI1N***	8		
AA23	BUSY/SISPI***	8		
AB22	RLM0_PLLCAP	3		
AC27	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-		
AC28	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AC29	PR101B	3	RLM0_GDLLC_IN_A**/RDQ99	C (LVDS)*
AC30	PR101A	3	RLM0_GDLLT_IN_A**/RDQ99	T (LVDS)*
AB30	PR100B	3	RLM0_GPLLC_IN_A**/RDQ99	C
VCCIO	VCCIO3	3		
AA30	PR100A	3	RLM0_GPLLT_IN_A**/RDQ99	T
AB29	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AB28	PR99A	3	RLM0_GPLLT_FB_A/RDQS99	T (LVDS)*
GNDIO	GNDIO3	-		
Y22	PR98B	3	RDQ99	C
Y23	PR98A	3	RDQ99	T
AB26	PR97B	3	RDQ99	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO3	3		
T22	PR69A	3	RDQ72	T
T29	PR68B	3	RDQ72	C (LVDS)*
T28	PR68A	3	RDQ72	T (LVDS)*
R23	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-		
-	-	-		
R22	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
P30	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
R29	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
T27	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
T26	PR64A	3	RDQ63	T
GNDIO	GNDIO3	-		
N30	PR61B	3	RDQ63	C (LVDS)*
N29	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
R27	PR60B	3	VREF2_3/RDQ63	C
R28	PR60A	3	VREF1_3/RDQ63	T
P29	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
P28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
M30	PR57B	2	PCLKC2_0/RDQ54	C
M29	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-		
P23	PR56B	2	RDQ54	C (LVDS)*
P24	PR56A	2	RDQ54	T (LVDS)*
R26	PR55B	2	RDQ54	C
P27	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
P25	PR54B	2	RDQ54	C (LVDS)*
P26	PR54A	2	RDQS54	T (LVDS)*
K30	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-		
K29	PR53A	2	RDQ54	T
N22	PR52B	2	RDQ54	C (LVDS)*
P22	PR52A	2	RDQ54	T (LVDS)*
J30	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2		
J29	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
N24	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
N23	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
N25	PR48B	2	RDQ45	C
N26	PR48A	2	RDQ45	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7			VCCIO7	7		
F4	PL9A	7	VREF2_7	T	PL9A	7	VREF2_7	T
F3	PL9B	7	VREF1_7	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
E1	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
E2	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
K9	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
H7	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
VCCIO	VCCIO7	7			VCCIO7	7		
F1	PL13A	7	LDQ15	T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F2	PL13B	7	LDQ15	C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
J8	PL14A	7	LDQ15	T	PL14A	7	LDQ15	T
H6	PL14B	7	LDQ15	C	PL14B	7	LDQ15	C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	PL15A	7	LDQS15	T (LVDS)*	PL15A	7	LDQS15	T (LVDS)*
G1	PL15B	7	LDQ15	C (LVDS)*	PL15B	7	LDQ15	C (LVDS)*
J7	PL16A	7	LDQ15	T	PL16A	7	LDQ15	T
VCCIO	VCCIO7	7			VCCIO7	7		
L8	PL16B	7	LDQ15	C	PL16B	7	LDQ15	C
L9	PL17A	7	LDQ15	T (LVDS)*	PL17A	7	LDQ15	T (LVDS)*
L10	PL17B	7	LDQ15	C (LVDS)*	PL17B	7	LDQ15	C (LVDS)*
H5	PL18A	7	LDQ15	T	PL18A	7	LDQ15	T
GNDIO	GNDIO7	-			GNDIO7	-		
J6	PL18B	7	LDQ15	C	PL18B	7	LDQ15	C
H2	NC	-			PL19A	7	LDQ23	T (LVDS)*
H1	NC	-			PL19B	7	LDQ23	C (LVDS)*
G5	NC	-			PL20A	7	LDQ23	T
G6	NC	-			PL20B	7	LDQ23	C
M9	NC	-			PL21A	7	LDQ23	T (LVDS)*
-	-	-			VCCIO7	7		
M10	NC	-			PL21B	7	LDQ23	C (LVDS)*
H3	NC	-			PL22A	7	LDQ23	T
H4	NC	-			PL22B	7	LDQ23	C
J2	PL19A	7		T (LVDS)*	PL23A	7	LDQS23	T (LVDS)*
-	-	-			GNDIO7	-		
J1	PL19B	7		C (LVDS)*	PL23B	7	LDQ23	C (LVDS)*
K2	PL20A	7		T	PL24A	7	LDQ23	T
K1	PL20B	7		C	PL24B	7	LDQ23	C
VCCIO	VCCIO7	7			VCCIO7	7		
J4	PL21A	7		T (LVDS)*	PL25A	7	LDQ23	T (LVDS)*
J3	PL21B	7		C (LVDS)*	PL25B	7	LDQ23	C (LVDS)*
J5	PL22A	7		T	PL26A	7	LDQ23	T
K5	PL22B	7		C	PL26B	7	LDQ23	C
GNDIO	GNDIO7	-			GNDIO7	-		
L2	PL24A	7	LDQ28	T (LVDS)*	PL28A	7	LDQ32	T (LVDS)*
L1	PL24B	7	LDQ28	C (LVDS)*	PL28B	7	LDQ32	C (LVDS)*
L7	PL25A	7	LDQ28	T	PL29A	7	LDQ32	T
K6	PL25B	7	LDQ28	C	PL29B	7	LDQ32	C
VCCIO	VCCIO7	7			VCCIO7	7		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AF1	PL78B	6	LDQ82	C (LVDS)*	PL95B	6	LDQ99	C (LVDS)*
AE5	PL79A	6	LDQ82	T	PL96A	6	LDQ99	T
AE6	PL79B	6	LDQ82	C	PL96B	6	LDQ99	C
AF4	PL80A	6	LDQ82	T (LVDS)*	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
AF3	PL80B	6	LDQ82	C (LVDS)*	PL97B	6	LDQ99	C (LVDS)*
AF5	PL81A	6	LDQ82	T	PL98A	6	LDQ99	T
AF6	PL81B	6	LDQ82	C	PL98B	6	LDQ99	C
AG1	PL82A	6	LLM0_GPLLT_IN_A**/LDQS82	T (LVDS)*	PL99A	6	LLM0_GPLLT_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
AG2	PL82B	6	LLM0_GPLLC_IN_A**/LDQ82	C (LVDS)*	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AE9	PL83A	6	LLM0_GPLLT_FB_A/LDQ82	T	PL100A	6	LLM0_GPLLT_FB_A/LDQ99	T
AF7	PL83B	6	LLM0_GPLLC_FB_A/LDQ82	C	PL100B	6	LLM0_GPLLC_FB_A/LDQ99	C
VCCIO	VCCIO6	6			VCCIO6	6		
AH1	PL84A	6	LLM0_GDLLT_IN_A**/LDQ82	T (LVDS)*	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AH2	PL84B	6	LLM0_GDLLC_IN_A**/LDQ82	C (LVDS)*	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AG5	PL85A	6	LLM0_GDLLT_FB_A/LDQ82	T	PL102A	6	LLM0_GDLLT_FB_A/LDQ99	T
AG4	PL85B	6	LLM0_GDLLC_FB_A/LDQ82	C	PL102B	6	LLM0_GDLLC_FB_A/LDQ99	C
GNDIO	GNDIO6	-			GNDIO6	-		
AG6	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
AJ1	PL87A	6		T	PL104A	6		T
AJ2	PL87B	6		C	PL104B	6		C
AK2	TCK	-			TCK	-		
AK1	TDI	-			TDI	-		
AL1	TMS	-			TMS	-		
AF10	TDO	-			TDO	-		
AK3	VCCJ	-			VCCJ	-		
AN2	LLC_SQ_VCCRX3	14			LLC_SQ_VCCRX3	14		
AM2	LLC_SQ_HDINP3	14		T	LLC_SQ_HDINP3	14		T
AN1	LLC_SQ_VCCIB3	14			LLC_SQ_VCCIB3	14		
AM3	LLC_SQ_HDINN3	14		C	LLC_SQ_HDINN3	14		C
AN3	LLC_SQ_VCCTX3	14			LLC_SQ_VCCTX3	14		
AP2	LLC_SQ_HDOUTP3	14		T	LLC_SQ_HDOUTP3	14		T
AM1	LLC_SQ_VCCOB3	14			LLC_SQ_VCCOB3	14		
AP3	LLC_SQ_HDOUTN3	14		C	LLC_SQ_HDOUTN3	14		C
AN4	LLC_SQ_VCCTX2	14			LLC_SQ_VCCTX2	14		
AP4	LLC_SQ_HDOUTN2	14		C	LLC_SQ_HDOUTN2	14		C
AL3	LLC_SQ_VCCOB2	14			LLC_SQ_VCCOB2	14		
AP5	LLC_SQ_HDOUTP2	14		T	LLC_SQ_HDOUTP2	14		T
AN5	LLC_SQ_VCCRX2	14			LLC_SQ_VCCRX2	14		
AM4	LLC_SQ_HDINN2	14		C	LLC_SQ_HDINN2	14		C
AL4	LLC_SQ_VCCIB2	14			LLC_SQ_VCCIB2	14		
AM5	LLC_SQ_HDINP2	14		T	LLC_SQ_HDINP2	14		T
AL6	LLC_SQ_VCCP	14			LLC_SQ_VCCP	14		
AL5	LLC_SQ_REFCLKP	14		T	LLC_SQ_REFCLKP	14		T
AK5	LLC_SQ_REFCLKN	14		C	LLC_SQ_REFCLKN	14		C
AK6	LLC_SQ_VCCAUX33	14			LLC_SQ_VCCAUX33	14		
AM6	LLC_SQ_HDINP1	14		T	LLC_SQ_HDINP1	14		T

LatticeECP2M S-Series Devices, Lead-Free Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	Com	20
LFE2M20SE-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	Com	20
LFE2M20SE-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	Com	20
LFE2M20SE-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	Com	20
LFE2M20SE-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	Com	20
LFE2M20SE-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	Com	35
LFE2M35SE-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	Com	35
LFE2M35SE-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	Com	35
LFE2M35SE-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	Com	35
LFE2M35SE-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	Com	35
LFE2M35SE-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	Com	35
LFE2M35SE-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	Com	35
LFE2M35SE-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	Com	35
LFE2M35SE-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	Com	50
LFE2M50SE-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	Com	50
LFE2M50SE-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	Com	50
LFE2M50SE-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	Com	50
LFE2M50SE-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	Com	50
LFE2M50SE-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	Com	50
LFE2M50SE-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	Com	50
LFE2M50SE-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	Com	50
LFE2M50SE-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	Com	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	Com	70
LFE2M70SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	70
LFE2M70SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	70
LFE2M70SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	70



LatticeECP2/M Family Data Sheet

Revision History

September 2013

Data Sheet DS1006

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
August 2006	01.1	Introduction	
			Updated Table 1-1 "LatticeECP2 Family Selection Guide".
		Architecture	Updated Figure 2-2 "PFU Diagram".
			Updated Figure 2-13 "Secondary Clock Regions ECP2-50".
			Updated Figure 2-25 "PIC Diagram".
			Updated Figure 2-26 "Input Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-28 "Output Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-30 "DQS Input Routing for Left and Right Edges".
			Updated Figure 2-32 "Edge Clock, DLL Calibration and DQS Local Bus Distribution".
			Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60.
			Replaced "CLKINDEL" with "CLKO".
			Updated SED section.
			Qualified device migration capability when using DQS banks for DDR interfaces.
		DC and Switching Characteristics	Added VCCPLL to the Recommended Operating Conditions table.
			Removed note 5 from "Hot Specifications" section.
			Added notes 7 and 8 to "Initialization Supply" Current table.
			Change note 6 - "...down to 95MHz" to "...down to 95MHz for DDR and 133MHz for DDR2" .
			New "Typical Building Block Function Performance" numbers.
			New External Switching Characteristics numbers.
			New Internal Switching Characteristics numbers.
			New Family Timing Adders numbers.
			Updated Timings for GPLLs, SPLLs and DLLs.
			Added sysCONFIG waveforms.
			Remove HSTL15D_II from sysIO Recommended Operating Conditions table.
			Updated Supply and Initialization Currents for ECP2-50.
		Pinout Information	Added VCCPLL to the Signal Descriptions table.
			Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50.
			Added Logic Signal Connections tables for ECP2-12 devices.
			Updated Pin Information Summary table to include ECP2-12.
			Updated Power Supply and NC Connections table to include ECP2-12.
			Added note 2 to DDR Strobe (DQS) Pin table.
			Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination.

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